### **Thermal Solutions**

P-THERM<sup>®</sup> Thermal Management Materials PS-264X Product Guide



The information provided in these technical data sheets is provided for reference only. All statements, recommendations and technical information are based upon tests we believe to be accurate and reliable. Polymer Science cannot assume responsibility for test results reported by other labs outside of our control as test methods may vary. The user, through his or her own testing, is responsible for making the final product selection assuring all performance, safety and warning requirements are met and the product is suitable for its intended use. Polymer Science disclaims all warranties, expressed or implied, including warranties of marketability or fitness for a particular use.

### **OUR SOLUTIONS**

Polymer Science is dedicated to being the most innovative thermal management material supplier in the world. We are excited to launch our newly formulated, improved performance P-THERM<sup>®</sup> thermal gap filler materials. Our new gap fillers offer many features that are required in today's evolving electronics market including:

- Economical and more cost effective
- Low outgassing
- Low leaching

Our diverse team of highly skilled engineers and technical staff, in conjunction with our state-of-the-art equipment, provide you with a quality product that is consistent with your application requirements.

Our design team works quickly to provide the solutions you need, allowing your project to expeditiously move from conception to commercialization giving you the edge to ensure your next project is a success.



# PS-264 |

#### **Product Description:**

P-THERM® PS-2641 is a silicone based thermally conductive gap filler with an embedded fiberglass support and 125 micron removable polyester carrier.

#### **Construction / Properties:**

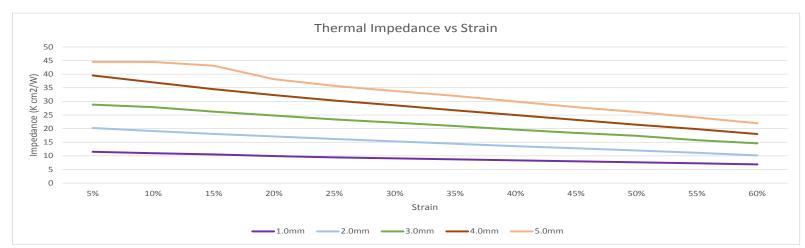
-	Property	Value	Test Method		
	Color	Dark Gray	Visual		
	Thickness Range	0.5 mm - 5.0 mm	ASTM D374		
	Carrier Type	Polyester Film			
ra	Carrier Thickness	125 micron			
Gene	Density (g/cc)	1.82	ASTM D792		
	Heat Capacity (J/g K)	0.974	ASTM EI269		
	Hardness (Shore 00)	22	ASTM D2240		
	Total Mass Loss (@ 125 C/24 hrs)	0.15%	ASTM E595**		
	Flammability Rating	V-0	UL 94		
	Continuous Use Conditions (C)	-40 - 200	QSP-754		
Electrical	Property	Value	Test Method		
	Dielectric Breakdown Strength (kV/mm)	12	ASTM D149		
	Volume Resistivity (ohm-meter)	1.00E+09	ASTM D257		

Thermal	Property	Value			Test Method	
	Thermal Conductivity	I W/m K			ASTM D5470*	
	Thermal Performance vs. Strain					
	Deflection (% Strain)	10	20	30	ASTM D5470***	
	Thermal Impedance (K cm²/W) @ 1mm	10.99	9.94	9.08	ASTM D5470	

\* Thermal conductivity tested at 20% strain.

\*\* Tested at atmospheric pressure

\*\*\* Values tested include interfacial thermal resistance: Application performance is directly related to surface roughness, flatness and pressure applied.



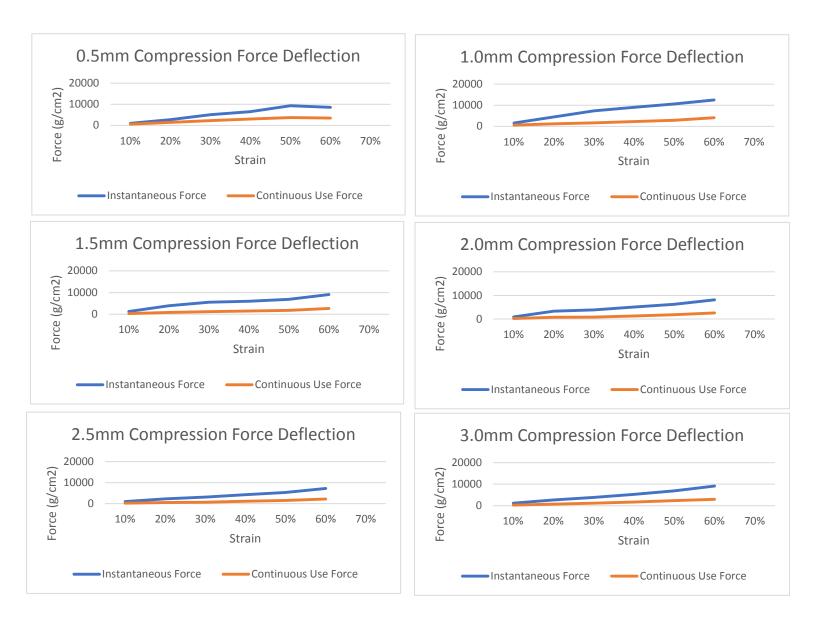
#### **Features:**

- Good Thermal Conductivity
- Excellent Compression Characteristics
- Excellent Wet-Out
- Superb Flexibility
- Excellent Converting Properties
- RoHS and HF Compliant

#### Blue Diamond Embossed LDPE Silicone with Embedded Fiberglass Support Polyester Carrier

#### **Applications:**

- LED Lighting
- Battery Components
- Infotainment Modules
- Smartphones
- Tablets
- Computers
- Digital Personal Assistants
- Automotive Lighting



## **PS-2642**

#### **Product Description:**

P-THERM® PS-2642 is a silicone based thermally conductive gap filler with an embedded fiberglass support and 125 micron removable polyester carrier.

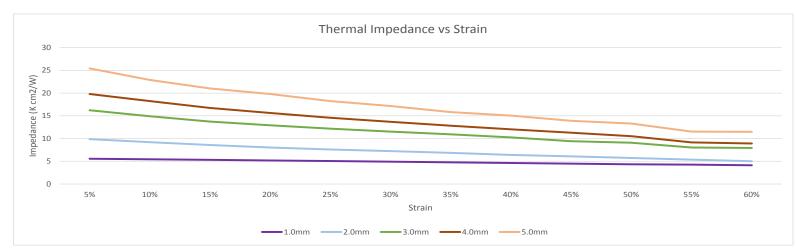
#### **Construction / Properties:**

	Property	Value			Test Method	
	Color	Light Blue			Visual	
	Thickness Range	0.5 mm - 5.0 mm			ASTM D374	
	Carrier Type	Polyester Film				
La la	Carrier Thickness	125 micron				
ene	Density (g/cc)	2.43			ASTM D792	
Ŭ	Heat Capacity (J/g K)	1.083			ASTM EI269	
	Hardness (Shore 00)	47			ASTM D2240	
	Total Mass Loss (@ 125C/24hrs)	0.08%			ASTM E595**	
	Flammability Rating	V-0			UL 94	
	Continuous Use Conditions (C)	-40 - 200			QSP-754	
- R	Property	Value			Test Method	
Electrical	Dielectric Breakdown Strength (kV/mm)	20			ASTM D149	
Ele	Volume Resistivity (ohm-meter)	1.00E+11			ASTM D257	
	Property	Value			Test Method	
Thermal	Thermal Conductivity	2 W/m K			ASTM D5470*	
	Thermal Performance vs. Strain					
	Deflection (% Strain)	10	20	30		
	Thermal Impedance (K cm²/W) @ 1mm	5.45	5.18	4.91	A3111 D3470	

\* Thermal conductivity tested at 20% strain.

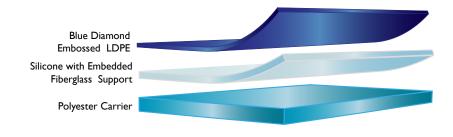
\*\* Tested at atmospheric pressure

\*\*\* Values tested include interfacial thermal resistance: Application performance is directly related to surface roughness, flatness and pressure applied.

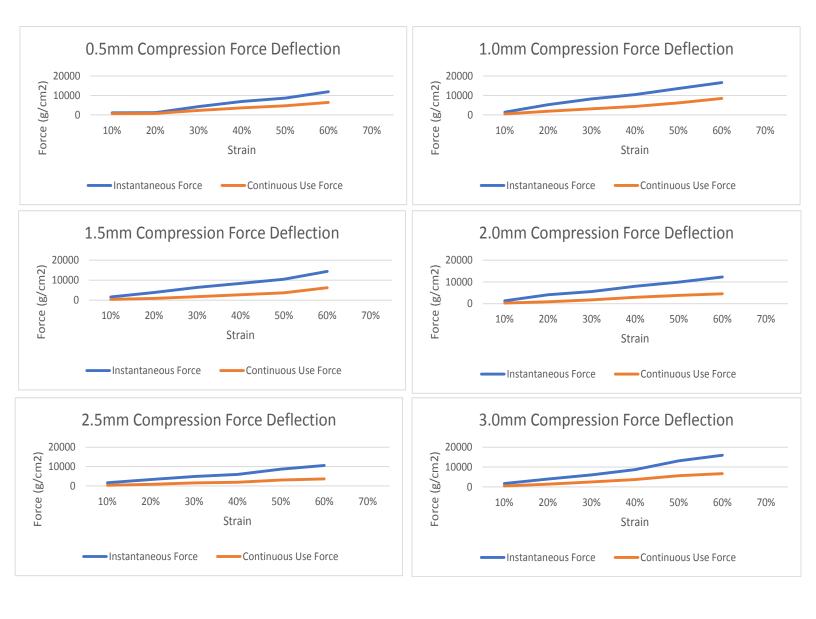


#### **Features:**

- Good Thermal Conductivity
- Excellent Compression Characteristics
- Excellent Wet-Out
- Superb Flexibility
- Excellent Converting Properties
- RoHS and HF Compliant



- Applications:LED Lighting
  - Battery Components
  - Infotainment Modules
  - Smartphones
  - Tablets
  - Computers
  - Digital Personal Assistants
  - Automotive Lighting



### **PS-2643**

#### **Product Description:**

P-THERM® PS-2643 is a silicone based thermally conductive gap filler with an embedded fiberglass support and 125 micron removable polyester carrier.

#### **Construction / Properties:**

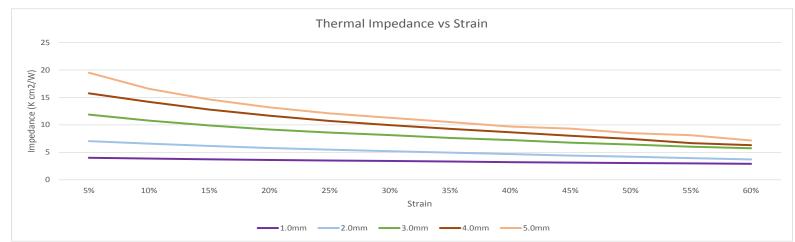
	Property	Value	Test Method		
	Color	Green	Visual		
	Thickness Range	0.5 mm - 5.0 mm	ASTM D374		
	Carrier Type	Polyester Film			
ra	Carrier Thickness	125 micron			
Genel	Density (g/cc)	2.73	ASTM D792		
	Heat Capacity (J/g K)	0.661	ASTM EI269		
	Hardness (Shore 00)	41	ASTM D2240		
	Total Mass Loss (@125 C/24 Hrs)	0.09%	ASTM E595**		
	Flammability Rating	V-0	UL 94		
	Continuous Use Conditions (C)	-40 - 200	QSP-754		
Electrical	Property	Value	Test Method		
	Dielectric Breakdown Strength (kV/mm)	13	ASTM D149		
	Volume Resistivity (ohm-meter)	1.00E+11	ASTM D257		

Thermal	Property	Value			Test Method	
	Thermal Conductivity	3 W/m K			ASTM D5470*	
	Thermal Performance vs. Strain					
	Deflection (% Strain)	10	20	30	ASTM D5470***	
	Thermal Impedance (K cm²/W) @ 1mm	3.87	3.62	3.43	ASTM D3470	

\* Thermal conductivity tested at 20% strain.

\*\* Tested at atmospheric pressure

\*\*\* Values tested include interfacial thermal resistance: Application performance is directly related to surface roughness, flatness and pressure applied.



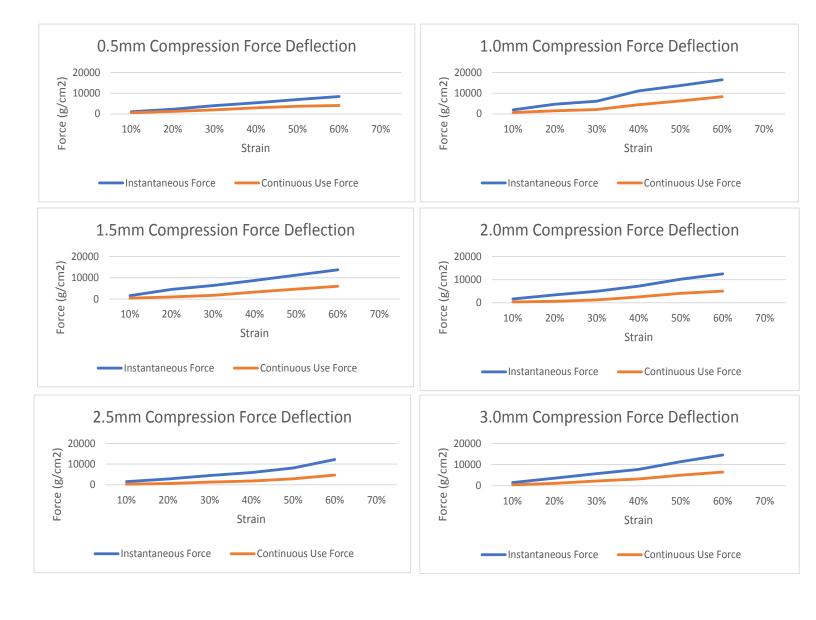
#### **Features:**

- Excellent Thermal Conductivity
- Excellent Compression Characteristics
- Good Wet-Out
- Superb Flexibility
- Excellent Converting Properties
- RoHS and HF Compliant

#### Blue Diamond Embossed LDPE Silicone with Embedded Fiberglass Support Polyester Carrier

#### **Applications:**

- LED Lighting
- Battery Components
- Infotainment Modules
- Smartphones
- Tablets
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- Digital Personal Assistants
- Automotive Lighting





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